Middle Power LED Series
2835

LM282B

6V General

Designed for better lm/$ (Lamps)

Features & Benefits

- 0.9W Class mid power LED
- Standard form factor for design flexibility (2.8 × 3.5 mm)

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1. Characteristics

a) Absolute Maximum Rating

Item	Symbol	Rating	Unit	Condition
Ambient / Operating Temperature	Ta	-40 ~ +80	°C	-
Storage Temperature	Tstg	-40 ~ +80	°C	-
LED Junction Temperature	Tj	115	°C	-
Forward Current	IF	**160**	mA	-
Peak Pulsed Forward Current	I_{Fp}	**320**	mA	Duty 1/10, pulse width 10ms
Assembly Process Temperature	-	260 <10	°C s	-
ESD (HBM)	-	2	kV	-

Note:

Proper current derating must be observed to maintain junction temperature below the maximum at all time.

b) Electro-optical Characteristics   (I_F = 150 mA, T_s = 25 °C)

Item	Unit	Rank	Bin	Min.	Typ.	Max.
Forward Voltage (VF)	V	GB	G1	5.7	-	6.0
			G2	6.0	-	6.3
			G3	6.3		6.6
			G4	6.6		6.9
Color Rendering Index (Ra)	-	5		80	-	-
Thermal Resistance (junction to solder point)	°C/W			-	15	-
Beam Angle	°			-	120	-

Note:

Samsung maintains measurement tolerance of: forward voltage = ±0.3 V, CRI = ±3

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b) Electro-optical Characteristics (I_F = 150 mA, T_s = 25 °C)

Item	CRI (R_a) Min.	Nominal CCT (K)	Bin		150mA	
					Min.	Max.
Luminous Flux (Φ_V)	80	2700	SA	S1	103	108
				S2	108	113
			SB	S3	113	118
				S4	118	123
		3000	SA	S1	105	110
				S2	110	115
			SB	S3	115	120
				S4	120	125
		3500	SA	S1	108	113
				S2	113	118
			SB	S3	118	123
				S4	123	128
		4000	SA	S1	110	115
				S2	115	120
			SB	S3	120	125
				S4	125	130
		5000	SA	S1	115	120
				S2	120	125
			SB	S3	125	130
				S4	130	135
		5700	SA	S1	113	118
				S2	118	123
			SB	S3	123	128
				S4	128	133
		6500	SA	S1	110	115
				S2	115	120
			SB	S3	120	125
				S4	125	130

Note:

Samsung maintains measurement tolerance of: forward voltage = ±0.3V, luminous flux = ±5 %, CRI = ±3

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2. Product Code Information

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S	P	M	W	H	1	2	2	1	F	D	5	G	B	R	O	S	0

Digit	PKG Information	Code	Specification
1 2 3	Samsung Package Middle Power	SPM	
4 5	Color	WH	White
6	Product Version	1	
7 8 9	Form Factor	221	2.8 x 3.5 x 0.65 mm; 2 pads; 2chip;
10	Sorting Current (mA)	F	150 mA
11	Chromaticity Coordinates	D	ANSI Standard
12	CRI	5	Min. 80
13 14	Forward Voltage (V)	GB	5.7~6.9 G1 5.7 ~ 6.0 G2 6.0 ~ 6.3 G3 6.3 ~ 6.6 G4 6.6 ~ 6.9
15 16	CCT (K)	W☆	2700 W1, W2, W3, W4, W5, W6, W7, W8, W9, WA, WB, WC, WD, WE, WF, WG
		V☆	3000 V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG
		U☆	3500 U1, U2, U3, U4, U5, U6, U7, U8, U9, UA, UB, UC, UD, UE, UF, UG
		T☆	4000 Bin Code: T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG
		R☆	5000 R1, R2, R3, R4, R5, R6, R7, R8, R9,RA,RB,RC,RD,RE,RF,RG
		Q☆	5700 Q1, Q2, Q3, Q4, Q5, Q6, Q7, Q8, Q9,QA,QB,QC,QD,QE,QF,QG
		P☆	6500 P1, P2, P3, P4, P5, P6, P7, P8, P9,PA,PB,PC,PD,PE,PF,PG
			☆ : "0" (Whole bin) "M" (Quarter bin) or "K" (kitting bin)
17 18	Luminous Flux	SA	S1, S2 Bin Code:
		SB	S3, S4

a) Luminous Flux Bins (I_F = 150 mA, T_s= 25ºC)

CRI (R_a) Min.	Nominal CCT (K)	Product Code	Flux Bin	Flux Range (Φ_v, lm)
80	2700	SPMWH1221FD5GBW☆SA	S1	103 ~ 108
			S2	108 ~ 113
		SPMWH1221FD5GBW☆SB	S3	113 ~ 118
			S4	118 ~ 123
	3000	SPMWH1221FD5GBV☆SA	S1	105 ~ 110
			S2	110 ~ 115
		SPMWH1221FD5GBV☆SB	S3	115 ~ 120
			S4	120 ~ 125
	3500	SPMWH1221FD5GBU☆SA	S1	108 ~ 113
			S2	113 ~ 118
		SPMWH1221FD5GBU☆SB	S3	118 ~ 123
			S4	123 ~ 128
	4000	SPMWH1221FD5GBT☆SA	S1	110 ~ 115
			S2	115 ~ 120
		SPMWH1221FD5GBT☆SB	S3	120 ~ 125
			S4	125 ~ 130
	5000	SPMWH1221FD5GBR☆SA	S1	115 ~ 120
			S2	120 ~ 125
		SPMWH1221FD5GBR☆SB	S3	125 ~ 130
			S4	130 ~ 135
	5700	SPMWH1221FD5GBQ☆SA	S1	113 ~ 118
			S2	118 ~ 123
		SPMWH1221FD5GBQ☆SB	S3	123 ~ 128
			S4	128 ~ 133
	6500	SPMWH1221FD5GBP☆SA	S1	110 ~ 115
			S2	115 ~ 120
		SPMWH1221FD5GBP☆SB	S3	120 ~ 125
			S4	125 ~ 130

Note: ☆" can be "0" (Whole bin), "M" (Quarter bin) or "K" (Kitting bin) of the color binning

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b) Kitting rule

1) Kitting bin Concept

1. Under agreement between customer and SAMSUNG ELECTRONICS, SAMSUNG can supply kitting bin (VF, Color, lm).
2. A forward voltage (VF) of kitting bin is combined by a pair of same VF rank such as (A3+A3), (A4+A4) or (A5+A5).
3. A Chromaticity Coordinates of kitting bin is mixed by kitting procedure.(below kitting simulation)

[Kitting example]
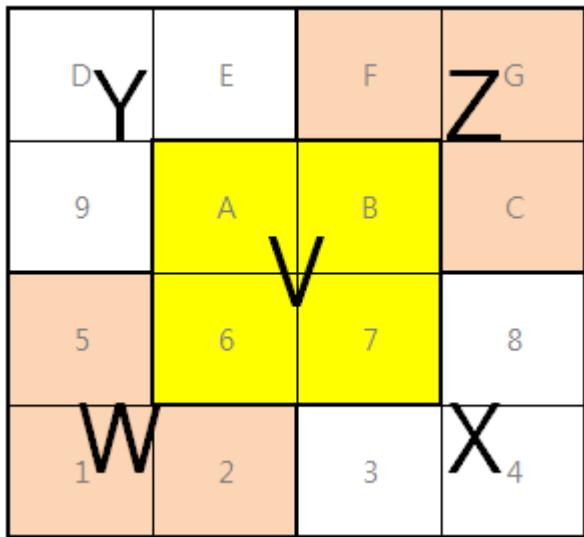
[Binning Information]

	Bin #1	Bin #2
VF	A2	A2
	A3	A3
	A4	A4
	A5	A5
CIE	W (1, 2, 5, 6 bin)	Z (B, C, F, G bin)
	V (6, 7, A, B bin)	V (6, 7, A, B bin)
	X (3, 4, 7, 8 bin)	Y (9, A, D, E bin)

※ Each of V, W, X, Y and Z can be one bin without details division

c) Color Bins (I_F = 150 mA, T_s = 25 ℃)

CRI (R_a) Min.	Nominal CCT (K)	Product Code	Color Rank	Chromaticity Bins
80	2700	SPMWH1221FD5GBW0S★	W0 (Whole bin)	W1, W2, W3, W4, W5, W6, W7, W8, W9, WA, WB, WC, WD, WE, WF, WG
		SPMWH1221FD5GBWMS★	WM (Quarter bin)	W6, W7, WA, WB
		SPMWH1221FD5GBWKS★	WK (Kitting bin)	WV, WW, WX, WY, WZ
	3000	SPMWH1221FD5GBV0S★	V0 (Whole bin)	V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG
		SPMWH1221FD5GBVMS★	VM (Quarter bin)	V6, V7, VA, VB
		SPMWH1221FD5GBVKS★	VK (Kitting bin)	VV, VW, VX, VY, VZ
	3500	SPMWH1221FD5GBU0S★	U0 (Whole bin)	U1, U2, U3, U4, U5, U6, U7, U8, U9, UA, UB, UC, UD, UE, UF, UG
		SPMWH1221FD5GBUMS★	UM (Quarter bin)	U6, U7, UA, UB
		SPMWH1221FD5GBUKS★	UK (Kitting bin)	UV, UW, UX, UY, UZ
	4000	SPMWH1221FD5GBT0S★	T0 (Whole bin)	T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG
		SPMWH1221FD5GBTMS★	TM (Quarter bin)	T6, T7, TA, TB
		SPMWH1221FD5GBTKS★	TK (Kitting bin)	TV, TW, TX, TY, TZ
	5000	SPMWH1221FD5GBR0S★	R0 (Whole bin)	R1, R2, R3, R4, R5, R6, R7, R8, R9 RA,RB,RC,RD,RE,RF,RG
		SPMWH1221FD5GBRMS★	RM (Quarter bin)	R6, R7, RA, RB
		SPMWH1221FD5GBRKS★	RK (Kitting bin)	RV, RW, RX, RY, RZ
	5700	SPMWH1221FD5GBQ0S★	Q0 (Whole bin)	Q1, Q2, Q3, Q4, Q5, Q6, Q7, Q8, Q9 QA,QB,QC,QD,QE,QF,QG
		SPMWH1221FD5GBQMS★	QM (Quarter bin)	Q6, Q7, QA, QB
		SPMWH1221FD5GBQKS★	QK (Kitting bin)	QV, QW, QX, QY, QZ
	6500	SPMWH1221FD5GBP0S★	P0 (Whole bin)	P1, P2, P3, P4, P5, P6, P7, P8, P9 PA,PB,PC,PD,PE,PF,PG
		SPMWH1221FD5GBPMS0★	PM (Quarter bin)	P6, P7, PA, PB
		SPMWH1221FD5GBPKS★	PK (Kitting bin)	PV, PW, PX, PY, PZ

Note: "★" can be "A" or "B" of the flux binning

d) Voltage Bins (I_F = 150 mA, T_s = 25 °C)

CRI (R_9) Min.	Nominal CCT (K)	Product Code	Voltage Rank	Voltage Bin	Voltage Range (V)
-	-	-	GB	G1	5.7 ~ 6.0
				G2	6.0 ~ 6.3
				G3	6.3 ~ 6.6
				G4	6.6 ~ 6.9

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e) Chromaticity Region & Coordinates (I_F = 150 mA, T_s = 25 ℃)

e) Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y	Region	CIE x	CIE y	Region	CIE x	CIE y
W rank (2700 K)						V rank (3000 K)					
W1	0.4373	0.3893	W9	0.4465	0.4071	V1	0.4147	0.3814	V9	0.4221	0.3984
	0.4418	0.3981		0.4513	0.4164		0.4183	0.3898		0.4259	0.4073
	0.4475	0.3994		0.4573	0.4178		0.4242	0.3919		0.4322	0.4096
	0.4428	0.3906		0.4523	0.4085		0.4203	0.3833		0.4281	0.4006
W2	0.4428	0.3906	WA	0.4523	0.4085	V2	0.4203	0.3833	VA	0.4281	0.4006
	0.4475	0.3994		0.4573	0.4178		0.4242	0.3919		0.4322	0.4096
	0.4532	0.4008		0.4634	0.4193		0.4300	0.3939		0.4385	0.4119
	0.4483	0.3919		0.4582	0.4099		0.4259	0.3853		0.4342	0.4028
W3	0.4483	0.3919	WB	0.4582	0.4099	V3	0.4259	0.3853	VB	0.4342	0.4028
	0.4532	0.4008		0.4634	0.4193		0.4300	0.3939		0.4385	0.4119
	0.4589	0.4021		0.4695	0.4207		0.4359	0.3960		0.4449	0.4141
	0.4538	0.3931		0.4641	0.4112		0.4316	0.3873		0.4403	0.4049
W4	0.4538	0.3931	WC	0.4641	0.4112	V4	0.4316	0.3873	VC	0.4403	0.4049
	0.4589	0.4021		0.4695	0.4207		0.4359	0.3960		0.4449	0.4141
	0.4646	0.4034		0.4756	0.4221		0.4418	0.3981		0.4513	0.4164
	0.4593	0.3944		0.4700	0.4126		0.4373	0.3893		0.4465	0.4071
W5	0.4418	0.3981	WD	0.4513	0.4164	V5	0.4183	0.3898	VD	0.4259	0.4073
	0.4465	0.4071		0.4562	0.4260		0.4221	0.3984		0.4299	0.4165
	0.4523	0.4085		0.4624	0.4274		0.4281	0.4006		0.4364	0.4188
	0.4475	0.3994		0.4573	0.4178		0.4242	0.3919		0.4322	0.4096
W6	0.4475	0.3994	WE	0.4573	0.4178	V6	0.4242	0.3919	VE	0.4322	0.4096
	0.4523	0.4085		0.4624	0.4274		0.4281	0.4006		0.4364	0.4188
	0.4582	0.4099		0.4687	0.4289		0.4342	0.4028		0.4430	0.4212
	0.4532	0.4008		0.4634	0.4193		0.4300	0.3939		0.4385	0.4119
W7	0.4532	0.4008	WF	0.4634	0.4193	V7	0.4300	0.3939	VF	0.4385	0.4119
	0.4582	0.4099		0.4687	0.4289		0.4342	0.4028		0.4430	0.4212
	0.4641	0.4112		0.4750	0.4304		0.4403	0.4049		0.4496	0.4236
	0.4589	0.4021		0.4695	0.4207		0.4359	0.3960		0.4449	0.4141
W8	0.4589	0.4021	WG	0.4695	0.4207	V8	0.4359	0.3960	VG	0.4449	0.4141
	0.4641	0.4112		0.4750	0.4304		0.4403	0.4049		0.4496	0.4236
	0.4700	0.4126		0.4813	0.4319		0.4465	0.4071		0.4562	0.4260
	0.4646	0.4034		0.4756	0.4221		0.4418	0.3981		0.4513	0.4164

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e) Chromaticity Region & Coordinates

U rank (3500 K)

Region	CIE x	CIE y	Region	CIE x	CIE y
U1	0.3889	0.3690	U9	0.3941	0.3848
	0.3915	0.3768		0.3968	0.3930
	0.3981	0.3800		0.4040	0.3966
	0.3953	0.3720		0.4010	0.3882
U2	0.3953	0.3720	UA	0.4010	0.3882
	0.3981	0.3800		0.4040	0.3966
	0.4048	0.3832		0.4113	0.4001
	0.4017	0.3751		0.4080	0.3916
U3	0.4017	0.3751	UB	0.4080	0.3916
	0.4048	0.3832		0.4113	0.4001
	0.4116	0.3865		0.4186	0.4037
	0.4082	0.3782		0.4150	0.3950
U4	0.4082	0.3782	UC	0.4150	0.3950
	0.4116	0.3865		0.4186	0.4037
	0.4183	0.3898		0.4259	0.4073
	0.4147	0.3814		0.4221	0.3984
U5	0.3915	0.3768	UD	0.3968	0.3930
	0.3941	0.3848		0.3996	0.4015
	0.4010	0.3882		0.4071	0.4052
	0.3981	0.3800		0.4040	0.3966
U6	0.3981	0.3800	UE	0.4040	0.3966
	0.4010	0.3882		0.4071	0.4052
	0.4080	0.3916		0.4146	0.4089
	0.4048	0.3832		0.4113	0.4001
U7	0.4048	0.3832	UF	0.4113	0.4001
	0.4080	0.3916		0.4146	0.4089
	0.4150	0.3950		0.4222	0.4127
	0.4116	0.3865		0.4186	0.4037
U8	0.4116	0.3865	UG	0.4186	0.4037
	0.4150	0.3950		0.4222	0.4127
	0.4221	0.3984		0.4299	0.4165
	0.4183	0.3898		0.4259	0.4073

T rank (4000 K)

Region	CIE x	CIE y	Region	CIE x	CIE y
T1	0.3670	0.3578	T9	0.3702	0.3722
	0.3726	0.3612		0.3763	0.3760
	0.3744	0.3685		0.3782	0.3837
	0.3686	0.3649		0.3719	0.3797
T2	0.3726	0.3612	TA	0.3763	0.3760
	0.3783	0.3646		0.3825	0.3798
	0.3804	0.3721		0.3847	0.3877
	0.3744	0.3685		0.3782	0.3837
T3	0.3783	0.3646	TB	0.3825	0.3798
	0.3840	0.3681		0.3887	0.3836
	0.3863	0.3758		0.3912	0.3917
	0.3804	0.3721		0.3847	0.3877
T4	0.3840	0.3681	TC	0.3887	0.3837
	0.3898	0.3716		0.3950	0.3875
	0.3924	0.3794		0.3978	0.3958
	0.3863	0.3758		0.3912	0.3917
T5	0.3686	0.3649	TD	0.3719	0.3797
	0.3744	0.3685		0.3782	0.3837
	0.3763	0.3760		0.3802	0.3916
	0.3702	0.3722		0.3736	0.3874
T6	0.3744	0.3685	TE	0.3782	0.3837
	0.3804	0.3721		0.3847	0.3877
	0.3825	0.3798		0.3869	0.3958
	0.3763	0.376		0.3802	0.3916
T7	0.3804	0.3721	TF	0.3847	0.3877
	0.3863	0.3758		0.3912	0.3917
	0.3887	0.3836		0.3937	0.4001
	0.3825	0.3798		0.3869	0.3958
T8	0.3863	0.3758	TG	0.3912	0.3917
	0.3924	0.3794		0.3978	0.3958
	0.3950	0.3875		0.4006	0.4044
	0.3887	0.3836		0.3937	0.4001

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e) Chromaticity Region & Coordinates

R rank (5000 K)

Region	CIE x	CIE y	Region	CIE x	CIE y
R1	0.3366	0.3369	R9	0.3371	0.3490
R1	0.3369	0.3430	R9	0.3374	0.3553
R1	0.3407	0.3460	R9	0.3415	0.3587
R1	0.3403	0.3398	R9	0.3411	0.3522
R2	0.3403	0.3398	RA	0.3411	0.3522
R2	0.3407	0.3460	RA	0.3415	0.3587
R2	0.3446	0.3491	RA	0.3457	0.3621
R2	0.3440	0.3427	RA	0.3451	0.3554
R3	0.3440	0.3427	RB	0.3451	0.3554
R3	0.3446	0.3491	RB	0.3457	0.3621
R3	0.3485	0.3522	RB	0.3500	0.3655
R3	0.3478	0.3457	RB	0.3492	0.3587
R4	0.3478	0.3457	RC	0.3492	0.3587
R4	0.3485	0.3522	RC	0.3500	0.3655
R4	0.3524	0.3554	RC	0.3542	0.3690
R4	0.3515	0.3487	RC	0.3533	0.3620
R5	0.3369	0.3430	RD	0.3374	0.3553
R5	0.3371	0.3490	RD	0.3376	0.3616
R5	0.3411	0.3522	RD	0.3420	0.3652
R5	0.3407	0.3460	RD	0.3415	0.3587
R6	0.3407	0.3460	RE	0.3415	0.3587
R6	0.3411	0.3522	RE	0.3420	0.3652
R6	0.3451	0.3554	RE	0.3463	0.3687
R6	0.3446	0.3491	RE	0.3457	0.3621
R7	0.3446	0.3491	RF	0.3457	0.3621
R7	0.3451	0.3554	RF	0.3463	0.3687
R7	0.3492	0.3587	RF	0.3507	0.3724
R7	0.3485	0.3522	RF	0.3500	0.3655
R8	0.3485	0.3522	RG	0.3500	0.3655
R8	0.3492	0.3587	RG	0.3507	0.3724
R8	0.3533	0.3620	RG	0.3551	0.3760
R8	0.3524	0.3554	RG	0.3542	0.3690

Q rank (5700 K)

Region	CIE x	CIE y	Region	CIE x	CIE y
Q1	0.3222	0.3243	Q9	0.3215	0.3350
Q1	0.3219	0.3297	Q9	0.3211	0.3406
Q1	0.3254	0.3328	Q9	0.3251	0.3442
Q1	0.3256	0.3272	Q9	0.3253	0.3384
Q2	0.3256	0.3272	QA	0.3253	0.3384
Q2	0.3254	0.3328	QA	0.3251	0.3442
Q2	0.3290	0.3359	QA	0.3290	0.3478
Q2	0.3290	0.3300	QA	0.3290	0.3417
Q3	0.3290	0.3300	QB	0.3290	0.3417
Q3	0.3290	0.3359	QB	0.3290	0.3478
Q3	0.3329	0.3394	QB	0.3332	0.3515
Q3	0.3328	0.3335	QB	0.3331	0.3454
Q4	0.3328	0.3335	QC	0.3331	0.3454
Q4	0.3329	0.3394	QC	0.3332	0.3515
Q4	0.3369	0.3430	QC	0.3374	0.3553
Q4	0.3366	0.3369	QC	0.3371	0.3490
Q5	0.3219	0.3297	QD	0.3211	0.3406
Q5	0.3215	0.3350	QD	0.3207	0.3462
Q5	0.3253	0.3384	QD	0.3249	0.3500
Q5	0.3254	0.3328	QD	0.3251	0.3442
Q6	0.3254	0.3328	QE	0.3251	0.3442
Q6	0.3253	0.3384	QE	0.3249	0.3500
Q6	0.3290	0.3417	QE	0.3290	0.3538
Q6	0.3290	0.3359	QE	0.3290	0.3478
Q7	0.3290	0.3359	QF	0.3290	0.3478
Q7	0.3290	0.3417	QF	0.3290	0.3538
Q7	0.3331	0.3454	QF	0.3333	0.3577
Q7	0.3329	0.3394	QF	0.3332	0.3515
Q8	0.3329	0.3394	QG	0.3332	0.3515
Q8	0.3331	0.3454	QG	0.3333	0.3577
Q8	0.3371	0.3490	QG	0.3376	0.3616
Q8	0.3369	0.3430	QG	0.3374	0.3553

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e)   Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
P rank (6500 K)					
P1	0.3068	0.3113	P9	0.3048	0.3207
	0.3106	0.3150		0.3089	0.3249
	0.3098	0.3199		0.3080	0.3298
	0.3058	0.3160		0.3038	0.3256
P2	0.3106	0.3150	PA	0.3089	0.3249
	0.3144	0.3186		0.3130	0.3290
	0.3137	0.3238		0.3123	0.3341
	0.3098	0.3199		0.3080	0.3298
P3	0.3144	0.3186	PB	0.3130	0.3290
	0.3183	0.3224		0.3172	0.3332
	0.3177	0.3278		0.3166	0.3384
	0.3137	0.3238		0.3123	0.3341
P4	0.3183	0.3224	PC	0.3172	0.3332
	0.3221	0.3261		0.3213	0.3373
	0.3217	0.3317		0.3209	0.3427
	0.3177	0.3278		0.3166	0.3384
P5	0.3058	0.3160	PD	0.3038	0.3256
	0.3098	0.3199		0.3080	0.3298
	0.3089	0.3249		0.3072	0.3348
	0.3048	0.3207		0.3028	0.3304
P6	0.3098	0.3199	PE	0.3080	0.3298
	0.3137	0.3238		0.3123	0.3341
	0.3130	0.3290		0.3115	0.3391
	0.3089	0.3249		0.3072	0.3348
P7	0.3137	0.3238	PF	0.3123	0.3341
	0.3177	0.3278		0.3166	0.3384
	0.3172	0.3332		0.3160	0.3436
	0.3130	0.3290		0.3115	0.3391
P8	0.3177	0.3278	PG	0.3166	0.3384
	0.3217	0.3317		0.3209	0.3427
	0.3213	0.3373		0.3205	0.3481
	0.3172	0.3332		0.3160	0.3436

Note: Samsung maintains measurement tolerance of: Cx, Cy = ±0.005

f)   Kitting Chromaticity Region & Coordinates (I_F = 150 mA, T_s = 25 °C)

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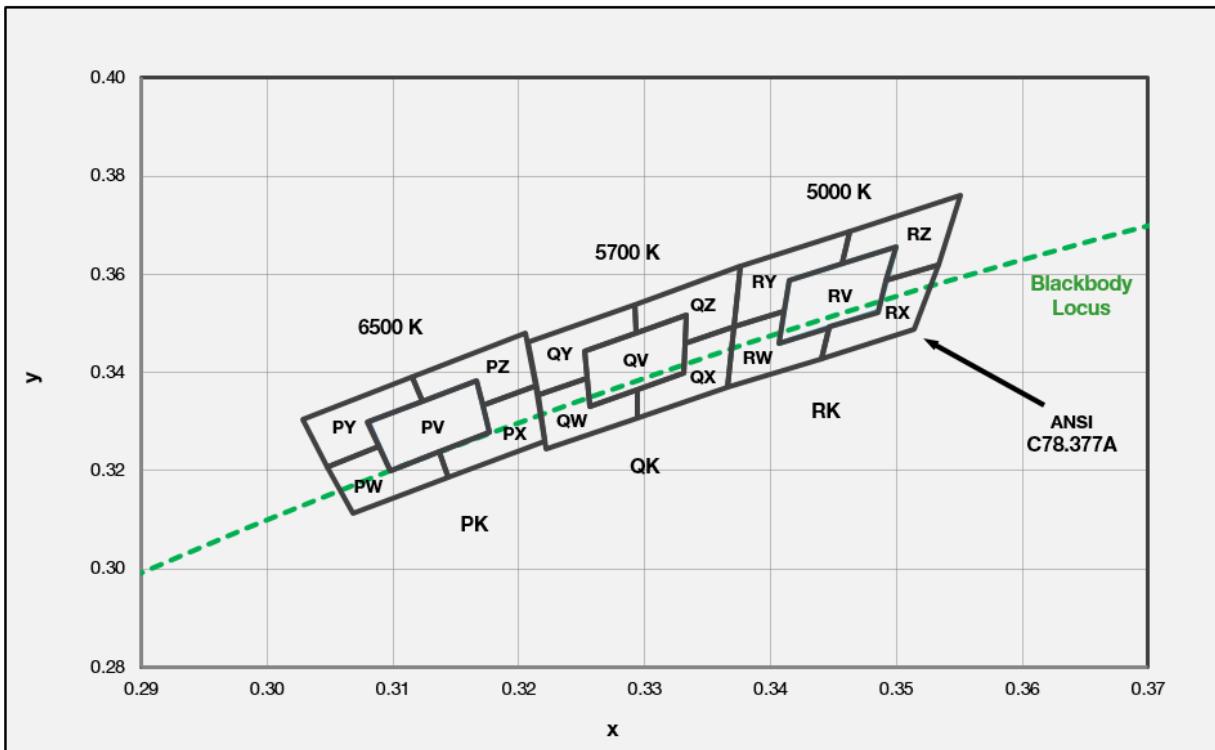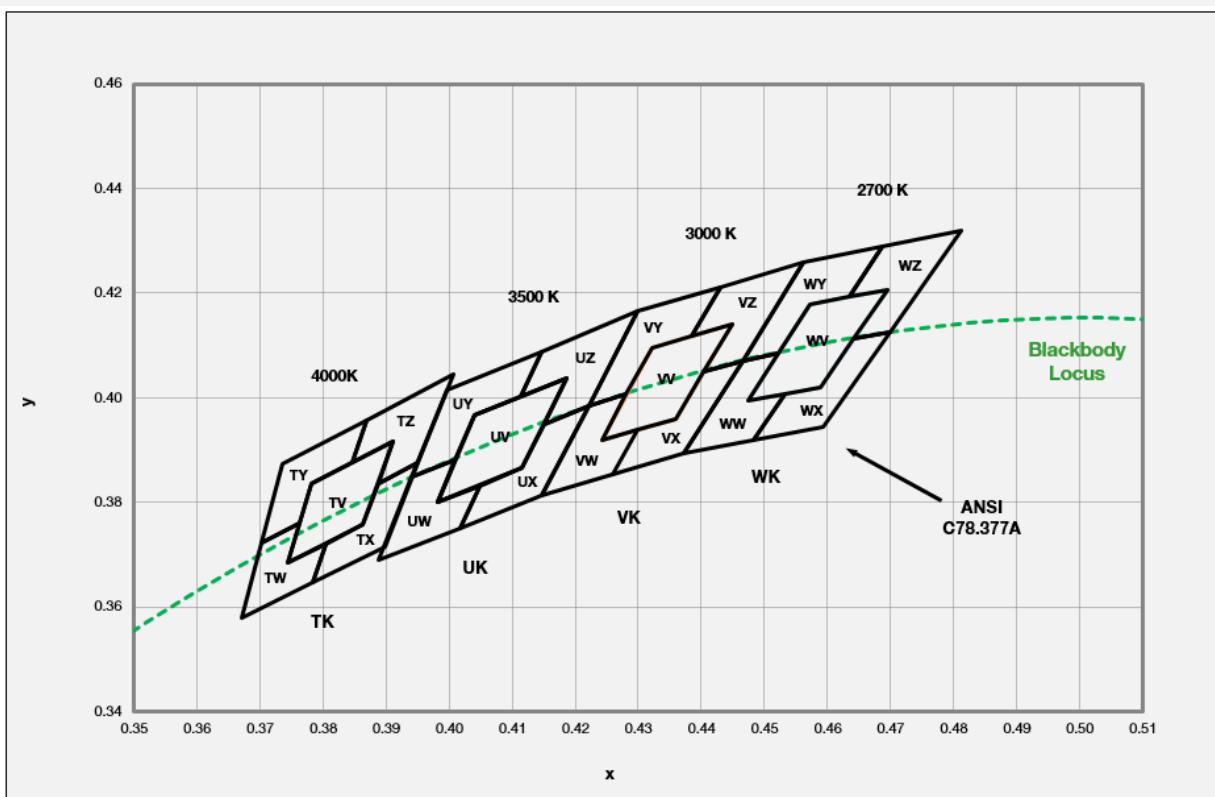
f) Kitting Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
W rank (2700 K)					
WV	0.4475	0.3994			
	0.4589	0.4021			
	0.4695	0.4207			
	0.4573	0.4178			
WW	0.4373	0.3893	WY	0.4465	0.4071
	0.4483	0.3919		0.4523	0.4085
	0.4532	0.4008		0.4573	0.4178
	0.4475	0.3994		0.4634	0.4193
	0.4523	0.4085		0.4687	0.4289
	0.4465	0.4071		0.4562	0.4260
WX	0.4483	0.3919	WZ	0.4641	0.4112
	0.4593	0.3944		0.4700	0.4126
	0.4700	0.4126		0.4813	0.4319
	0.4641	0.4112		0.4687	0.4289
	0.4589	0.4021		0.4634	0.4193
	0.4532	0.4008		0.4695	0.4207

Region	CIE x	CIE y	Region	CIE x	CIE y
V rank (3000 K)					
VV	0.4242	0.3919			
	0.4359	0.3960			
	0.4449	0.4141			
	0.4322	0.4096			
VW	0.4147	0.3814	VY	0.4221	0.3984
	0.4259	0.3853		0.4281	0.4006
	0.4300	0.3939		0.4322	0.4096
	0.4242	0.3919		0.4385	0.4119
	0.4281	0.4006		0.4430	0.4212
	0.4221	0.3984		0.4299	0.4165
VX	0.4259	0.3853	VZ	0.4403	0.4049
	0.4373	0.3893		0.4465	0.4071
	0.4465	0.4071		0.4562	0.4260
	0.4403	0.4049		0.4430	0.4212
	0.4359	0.3960		0.4385	0.4119
	0.4300	0.3939		0.4449	0.4141

Region	CIE x	CIE y	Region	CIE x	CIE y
U rank (3500 K)					
UV	0.3981	0.3800			
	0.4116	0.3865			
	0.4186	0.4037			
	0.4040	0.3966			
UW	0.3889	0.3690	UY	0.3941	0.3848
	0.4017	0.3751		0.4010	0.3882
	0.4048	0.3832		0.4040	0.3966
	0.3981	0.3800		0.4113	0.4001
	0.4010	0.3882		0.4146	0.4089
	0.3941	0.3848		0.3996	0.4015
UX	0.4017	0.3751	UZ	0.4150	0.3950
	0.4147	0.3814		0.4221	0.3984
	0.4221	0.3984		0.4299	0.4165
	0.4150	0.3950		0.4146	0.4089
	0.4116	0.3865		0.4113	0.4001
	0.4048	0.3832		0.4186	0.4037

Region	CIE x	CIE y	Region	CIE x	CIE y
T rank (4000 K)					
TV	0.3744	0.3685			
	0.3863	0.3758			
	0.3912	0.3917			
	0.3782	0.3837			
TW	0.3670	0.3578	TY	0.3702	0.3722
	0.3783	0.3646		0.3763	0.3760
	0.3804	0.3721		0.3782	0.3837
	0.3744	0.3685		0.3847	0.3877
	0.3763	0.3760		0.3869	0.3958
	0.3702	0.3722		0.3736	0.3874
TX	0.3783	0.3646	TZ	0.3887	0.3837
	0.3898	0.3716		0.3950	0.3875
	0.3950	0.3875		0.4006	0.4044
	0.3887	0.3837		0.3869	0.3958
	0.3863	0.3758		0.3847	0.3877
	0.3804	0.3721		0.3912	0.3917

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f) Kitting Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
R rank (5000 K)					
RV	0.3407	0.3460			
	0.3485	0.3524			
	0.3500	0.3655			
	0.3415	0.3588			
RW	0.3366	0.3369	RY	0.3371	0.3493
	0.3440	0.3427		0.3411	0.3525
	0.3446	0.3491		0.3415	0.3588
	0.3407	0.3460		0.3457	0.3621
	0.3411	0.3525		0.3463	0.3687
	0.3371	0.3493		0.3376	0.3616
RX	0.3440	0.3428	RZ	0.3457	0.3621
	0.3514	0.3487		0.3500	0.3655
	0.3533	0.3620		0.3492	0.3587
	0.3492	0.3587		0.3533	0.3620
	0.3485	0.3522		0.3551	0.3760
	0.3446	0.3493		0.3463	0.3687

Region	CIE x	CIE y	Region	CIE x	CIE y
Q rank (5700 K)					
QV	0.3256	0.3331			
	0.3331	0.3398			
	0.3333	0.3518			
	0.3252	0.3444			
QW	0.3222	0.3243	QY	0.3215	0.3353
	0.3294	0.3306		0.3254	0.3388
	0.3294	0.3364		0.3252	0.3444
	0.3256	0.3331		0.3293	0.3481
	0.3254	0.3388		0.3292	0.3539
	0.3215	0.3353		0.3207	0.3462
QX	0.3294	0.3306	QZ	0.3293	0.3481
	0.3366	0.3369		0.3333	0.3518
	0.3371	0.3493		0.3332	0.3458
	0.3332	0.3458		0.3371	0.3493
	0.3331	0.3398		0.3376	0.3616
	0.3294	0.3364		0.3292	0.3539

Region	CIE x	CIE y	Region	CIE x	CIE y
P rank (6500 K)					
PV	0.3098	0.3199			
	0.3177	0.3278			
	0.3166	0.3384			
	0.3080	0.3298			
PW	0.3068	0.3113	PY	0.3048	0.3207
	0.3144	0.3186		0.3089	0.3249
	0.3137	0.3238		0.308	0.3298
	0.3098	0.3199		0.3123	0.3341
	0.3089	0.3249		0.3115	0.3391
	0.3048	0.3207		0.3028	0.3304
PX	0.3144	0.3186	PZ	0.3123	0.3341
	0.3221	0.3261		0.3166	0.3384
	0.3213	0.3373		0.3172	0.3332
	0.3172	0.3332		0.3213	0.3373
	0.3177	0.3278		0.3205	0.3481
	0.3137	0.3238		0.3115	0.3391

Note:

Samsung maintains measurement tolerance of: Cx, Cy = ±0.005

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3. Typical Characteristics Graphs

a) Spectrum Distribution   (I_F = 150 mA, T_s = 25 °C)

CCT: 2700 K (80 CRI)
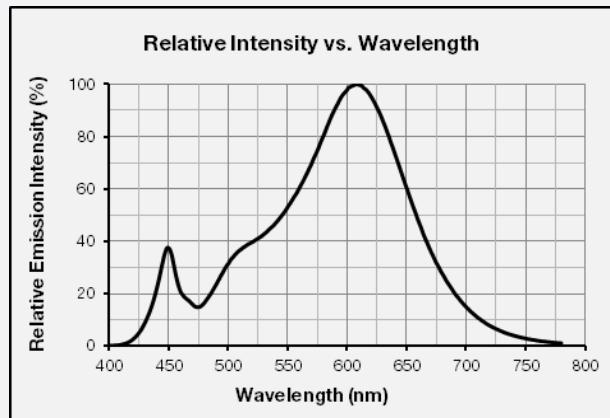
CCT: 3000 K (80 CRI)
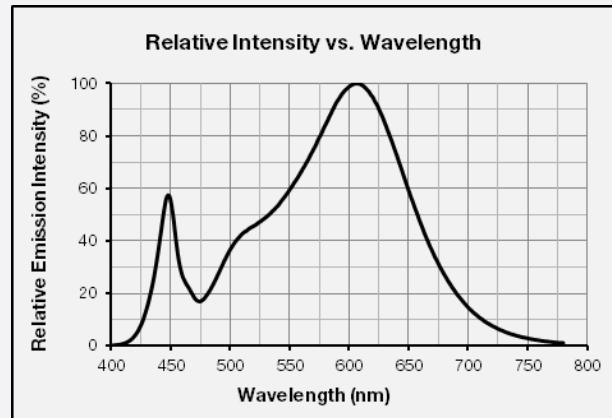
CCT: 3500 K (80 CRI)
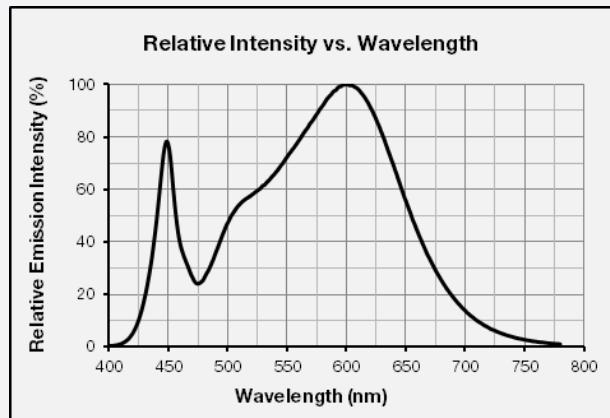
CCT: 4000 K (80 CRI)
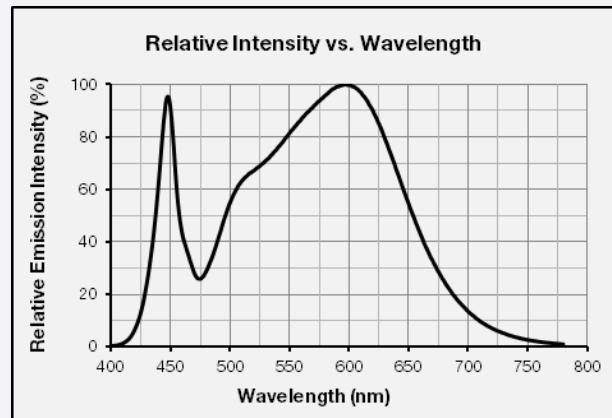
CCT: 5000 K (80 CRI)

CCT: 5700 K (80 CRI)

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CCT: 6500 K (80 CRI)

Relative Intensity vs. Wavelength
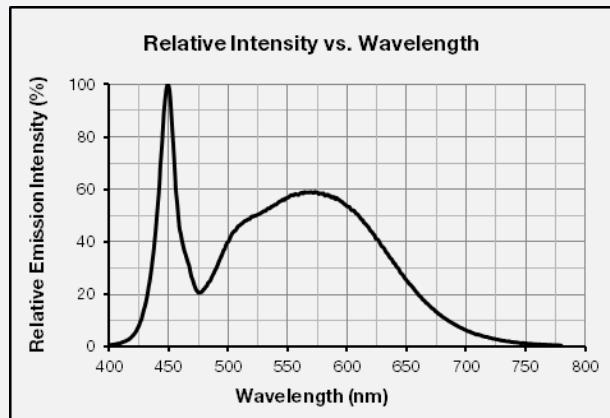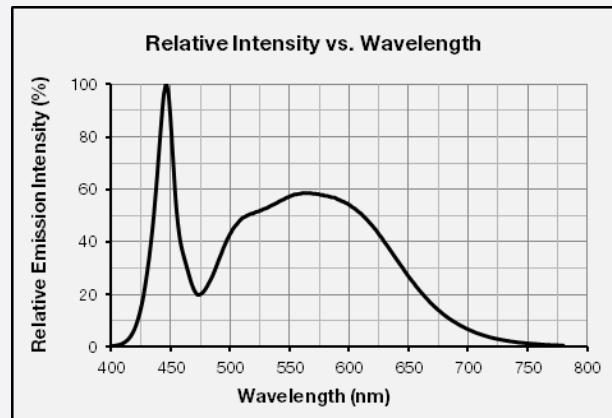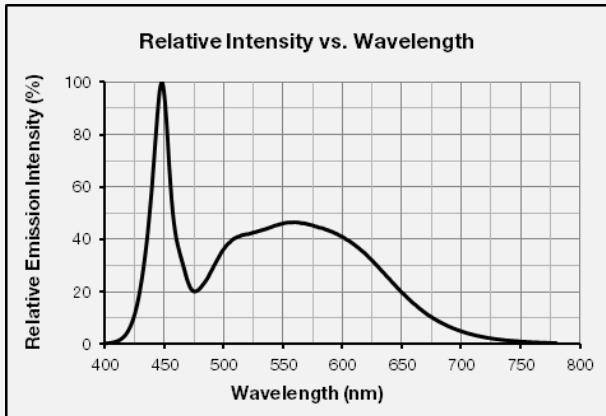
b) Forward Current Characteristics (Ts = 25 °C)

Relative Luminous Flux vs. Forward Current

Forward Current vs. Forward Voltage
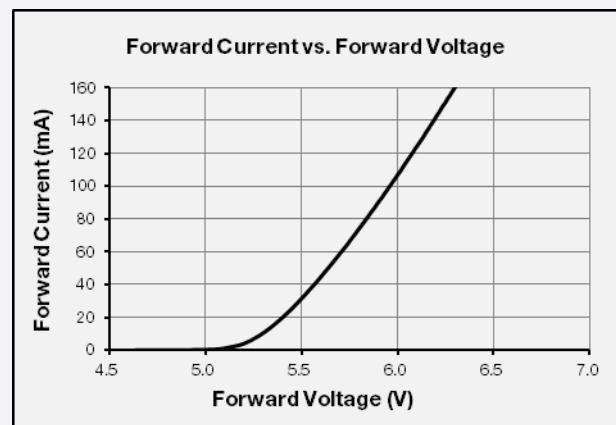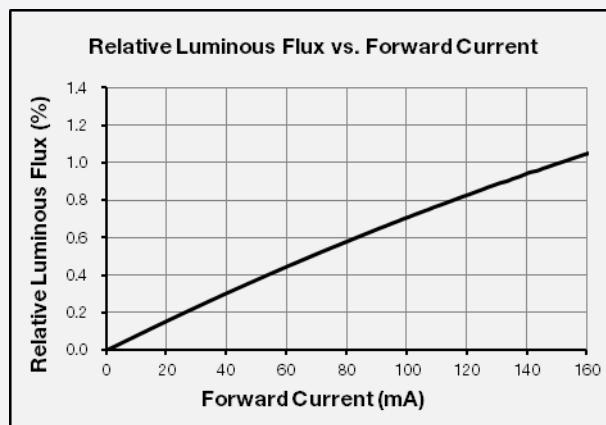
c) Temperature Characteristics (IF = 150 mA)

Relative Luminous Flux vs. Temperature

Relative Forward Voltage vs. Temperature

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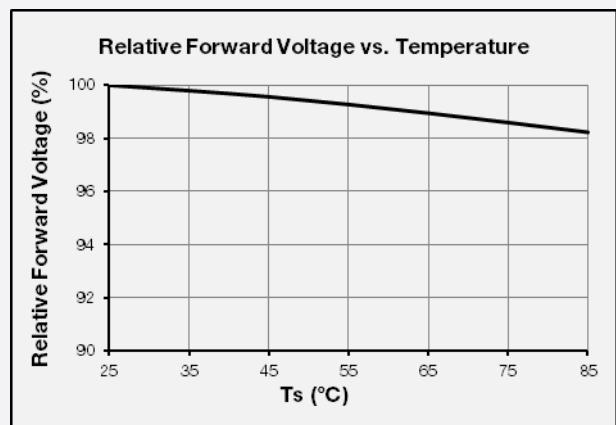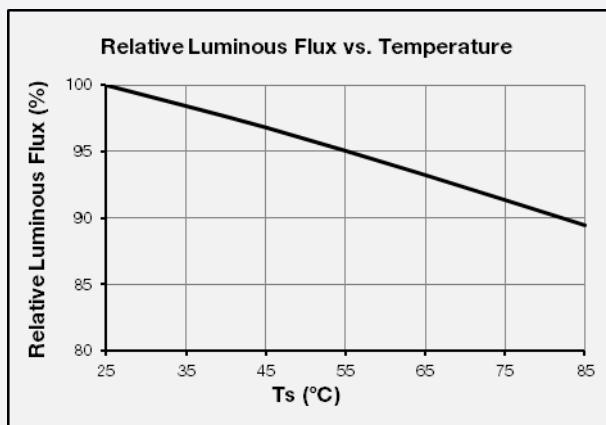
d) Color Shift Characteristics (IF = 150 mA, Ts = 25 °C)

△ CIE x, △ CIE y vs. Forward Current

△ CIE x, △ CIE y vs. Temperature
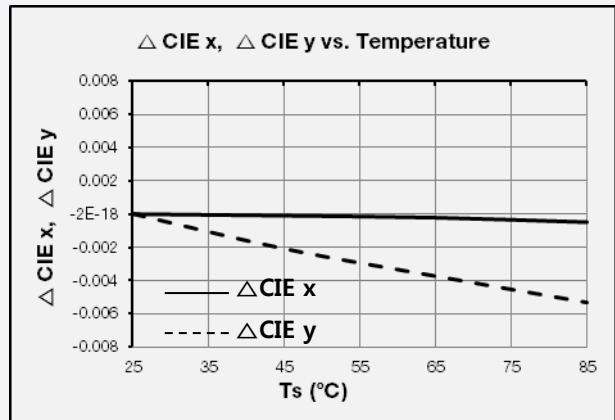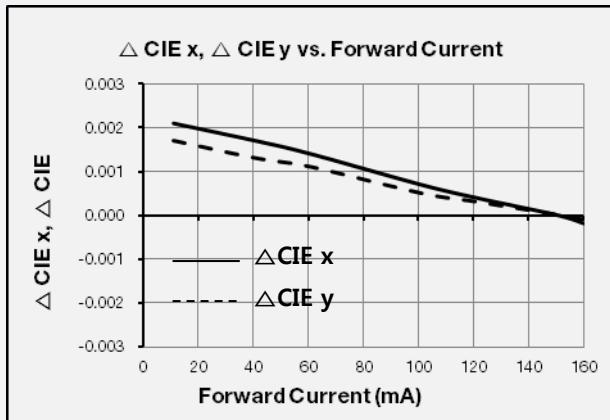
e) Derating Curve

Derating Curve
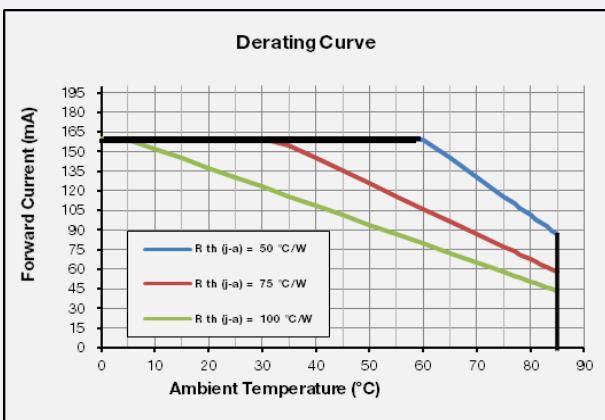
f) Beam Angle Characteristics (IF = 150 mA, Ts = 25 °C)

Radiation Diagram

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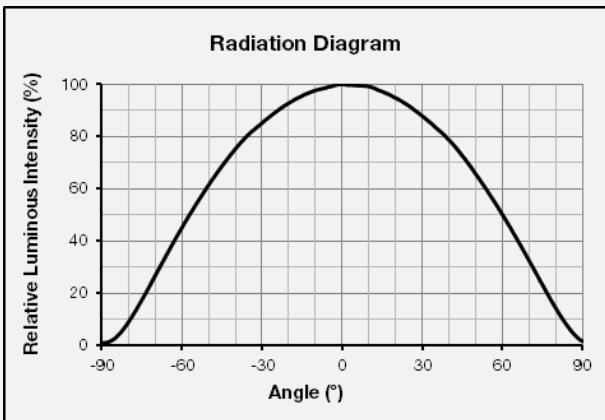
4. Outline Drawing & Dimension

• Measurement unit: mm
• Tolerance : ±0.1mm
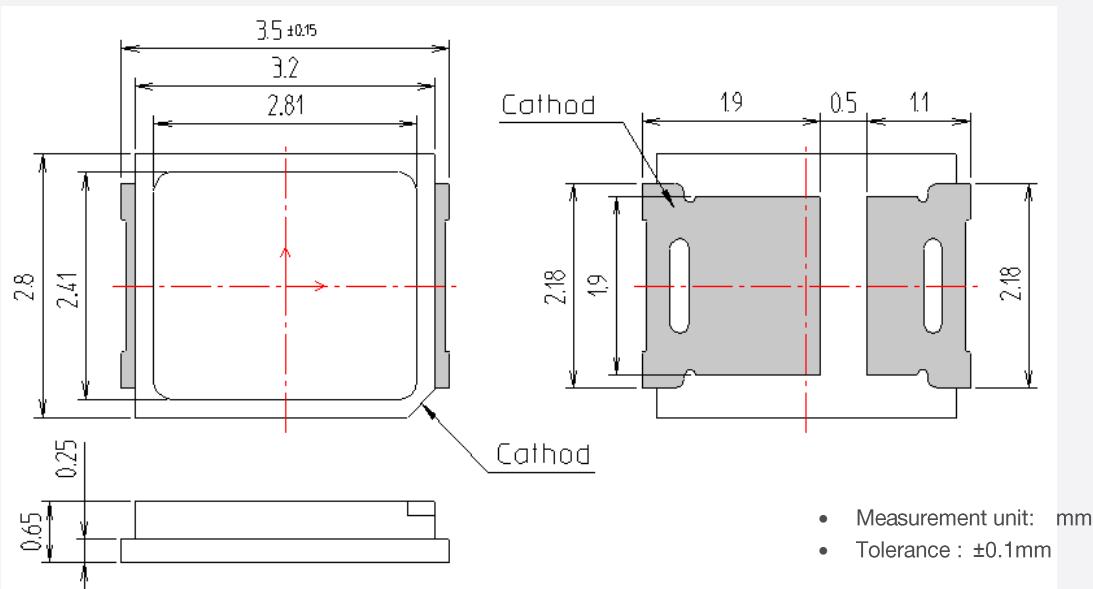
[Recommended PCB Solder PAD]
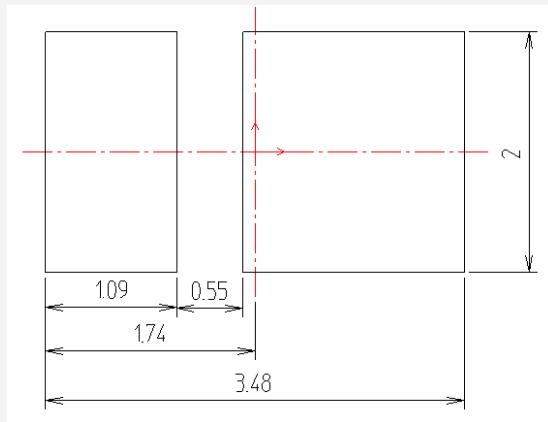
Notes:

1) This LED has built-in ESD protection device(s) connected in parallel to LED chip(s).

2) T_s point and measurement method:
   ① Measure one point at the cathode pad, if necessary remove PSR of PCB to reach T_s point.
   ② All pads must be soldered to the PCB to dissipate heat properly, otherwise the LED can be damaged.

Precautions:

1) Pressure on the LEDs will influence to the reliability of the LEDs. Precautions should be taken to avoid strong pressure on the LEDs. Do not put stress on the LEDs during heating.

2) Re-soldering should not be done after the LEDs have been soldered. If re-soldering is unavoidable, LED`s characteristics should be carefully checked before and after such repair.

3) Do not stack assembled PCBs together. Since materials of LEDs is soft, abrasion between two PCB assembled with LED might cause catastrophic failure of the LEDs.

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5. Reliability Test Items & Conditions

a) Test Items

Test Item	Test Condition	Test Hour / Cycle	Sample No.
Room Temperature Life Test	25 °C, DC 160 mA	1000 h	22
High Temperature Life Test	85 °C, DC 160 mA	1000 h	22
High Temperature Humidity Life Test	85 °C, 85 % RH, DC 160 mA	1000 h	22
Low Temperature Life Test	-40 °C, DC 160 mA	1000 h	22
Powered Temperature Cycle Test	-45 °C ~ 85 °C, each 20 min, on/off 5 min Temp. Change time 100min, DC 160 mA	100 cycles	22
Temperature Cycling	-45 °C / 15 min ↔ 125 °C / 15 min	200 cycles	100
High Temperature Storage	120 °C	1000 h	11
Low Temperature Storage	-40 °C	1000 h	11
ESD (HBM)	R_1: 10 MΩ R_2: 1.5 kΩ C: 100 pF V: ±2 kV	5 times	30
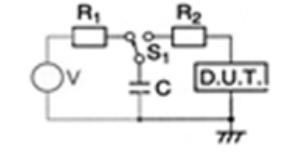
b) Criteria for Judging the Damage

Item	Symbol	Test Condition ($T_s = 25$ °C)	Limit Min	Limit Max
Forward Voltage	V_F	$I_F = 160$ mA	Init. Value * 0.9	Init. Value * 1.1
Luminous Flux	Φ_v	$I_F = 160$ mA	Init. Value * 0.7	Init. Value * 1.1

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6. Soldering Conditions

### a) Reflow Conditions (Pb free)

Reflow frequency: 2 times max.
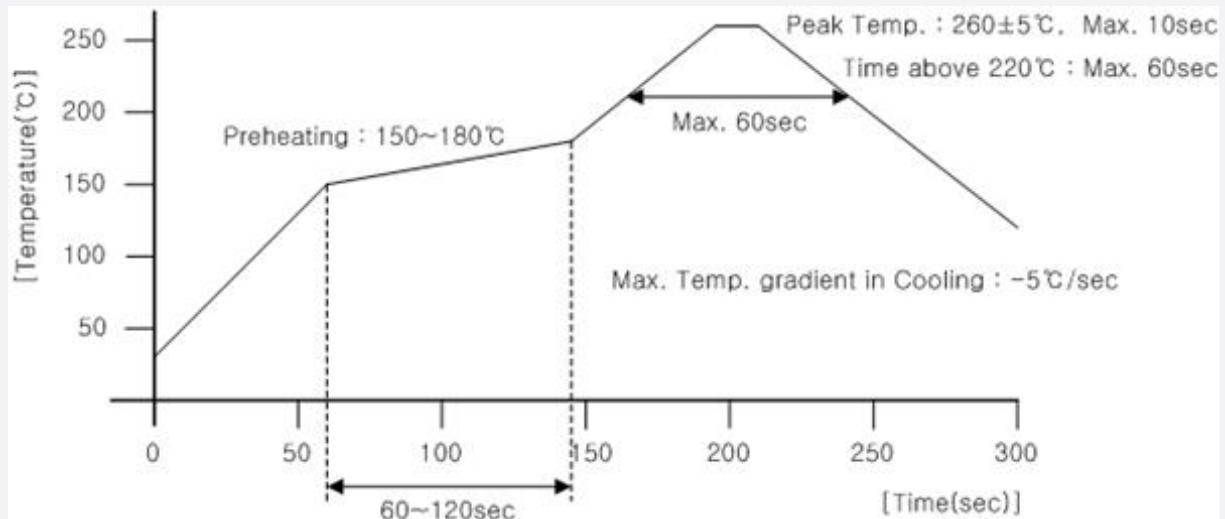
b) Manual Soldering Conditions

Not more than 5 seconds @ max. 300 ºC, under soldering iron.

## 7. Tape & Reel

a) Taping Dimension

User Feed Direction

POLARITY MARK

END | Ø1.5 | 4 | START

1.75 | 8 | 3.5

1.05 | 0.25 | 3.72

Traller
160mm (min.) of empty pockets sealed with tape
(40 pockets min.)

Loaded pockets
4000 pcs / reel

Leader
400mm (min.) of empty pockets sealed with tape
(100 pockets min.)

3

Taping Diretion

End

Start

More than 40 ㎜
Unloaded tape

Mounted with
LED package

More than 100~200 ㎜
Unloaded tape

Leading part more than
500 mm

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b) **Reel Dimension**

(unit: mm)
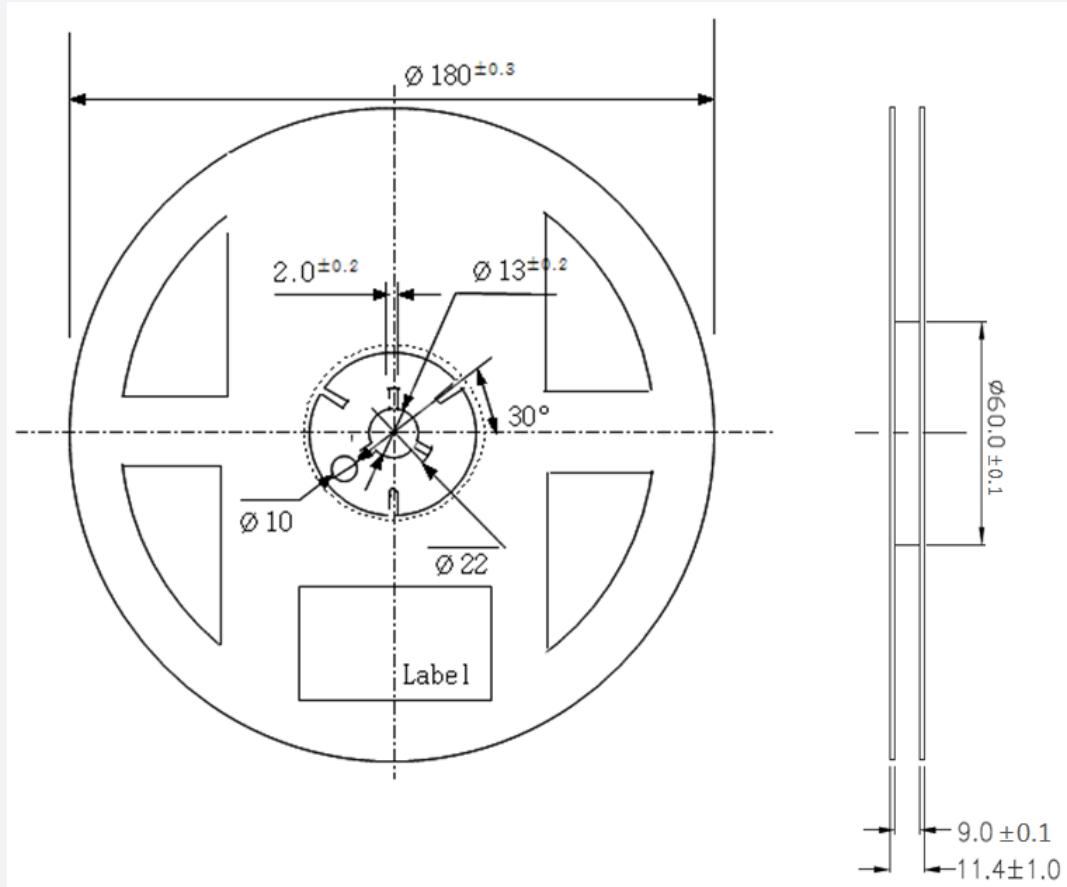
Notes:

1) Quantity: The quantity/reel is 4,000 pcs

2) All dimensions are millimeters (tolerance : ±0.2mm)

3) Packaging: P/N, Manufacturing data code no. and quantity are indicated on the aluminum packing bag

8. Label Structure

a) Label Structure

```
          ⓐⓑⓒⓓⓔⓕ
          G2R1S3
SPMWH1221FD5GBR0S3  G2R1S3  01
||||||||||||||||||||||||||||||||||||
G3AYC4001 / 1001 / 4,000 pcs
||||||||||||||||||||||||||||||||||||
SAMSUNG
```

Bin Code

Product Code
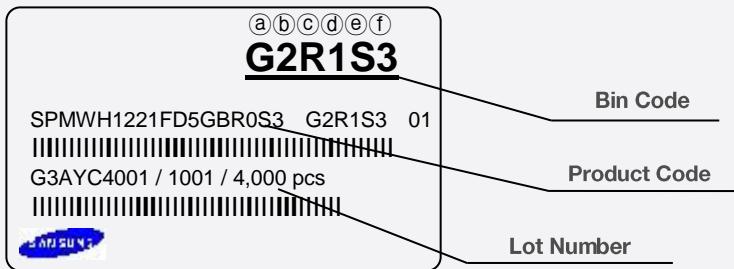
Lot Number

Note: Denoted bin code and product code above is only an example (see description on page 5)

Bin Code:

ⓐⓑ:   Forward Voltage bin   (refer to page 9)

ⓒⓓ:   Chromaticity bin   (refer to page 10-17)

ⓔⓕ:   Luminous Flux bin   (refer to page 6)

b) Lot Number

The lot number is composed of the following characters:

```
          G2R1S3
SPMWH1221FD5GBR0S3  G2R1S3 01
||||||||||||||||||||||||||||||||||||
①②③④⑤⑥⑦⑧⑨/1ⓐⓑⓒ/ 4,000 pcs
||||||||||||||||||||||||||||||||||||
SAMSUNG
```

①②③④⑤⑥⑦⑧⑨ / 1ⓐⓑⓒ / 4,000 pcs

①   : Production site   (S: Giheung, Korea,   G: Tianjin, China)

②   : 3   (LED)

③   : Product state   (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)

④   : Year   (Z: 2015, A: 2016, B: 2017…)

⑤   : Month   (1~9, A, B, C)

⑥⑦⑧⑨   : Day   (1~9, A, B~V)

ⓐⓑⓒ   : Product serial number   (001 ~ 999)

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9. Packing Structure

a) Packing Process

Reel

G2R1S3

SPMWH1221FD5GBR0S3 G2R1S3   01
|||||||||||||||||||||||||||||||||||||||||||||
G3AYC4001 / 1001 / 4,000 pcs
|||||||||||||||||||||||||||||||||||||

Aluminum Vinyl Packing Bag

G2R1S3

SPMWH1221FD5GBR0S3 G2R1S3   01
|||||||||||||||||||||||||||||||||||||||||||||
G3AYC4001 / 1001 / 4,000 pcs
|||||||||||||||||||||||||||||||||||||
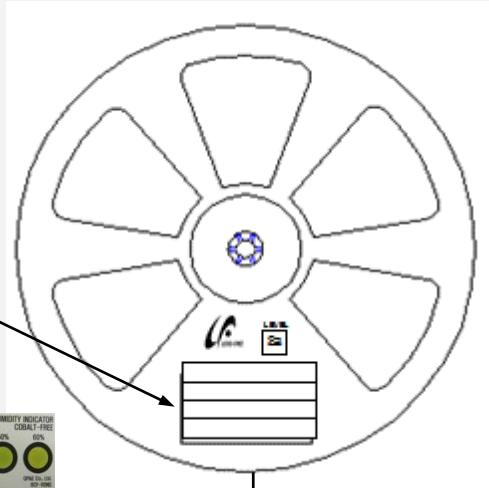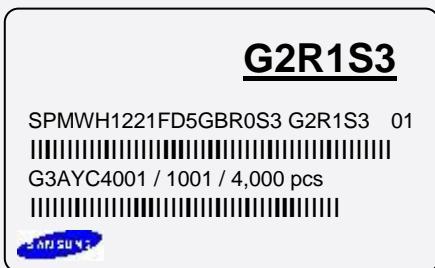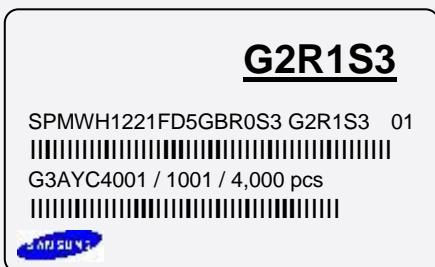
Outer Box

Material: Paper (SW3B(B))

Type	Size (mm)			Note
	L	W	H	
7 inch L	245 ± 5	220 ± 5	182 ± 5	Up to 10 reels
7 inch S	245 ± 5	220 ± 5	86 ± 5	Up to 5 reels

① **Side Label**

G2R1S3

SPMWH1221FD5GBR0S3 G2R1S3   01
|||||||||||||||||||||||||||||||||||||||||
G3AYC4001 / 1001 / 40,000 pcs
|||||||||||||||||||||||||||||||||||||

H

LED

W

L
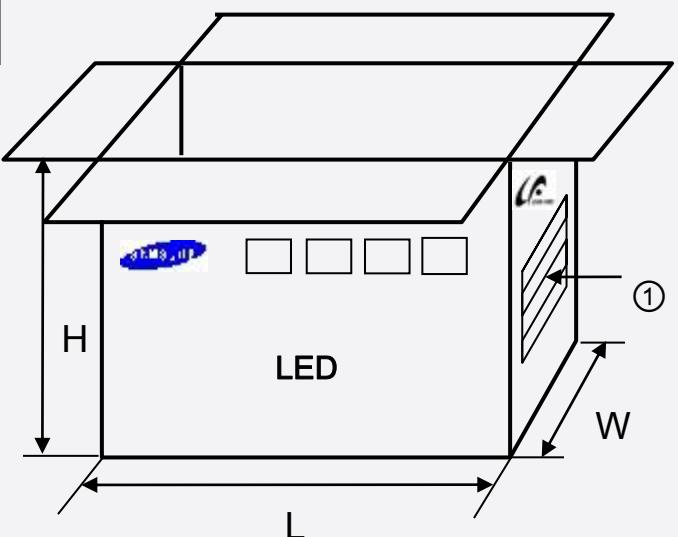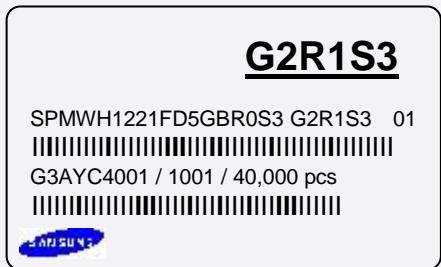
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b) Packing Process for kitting

Reel

Kitting 'A'

G2★WS3
SPMWH1221FD5GB★KS0 G2★WS3 01

G3AW94001 / 1001 / 4,000 pcs

Kitting 'B'

G2★ZS3
SPMWH1221FD5GB★KS0 G2★ZS3 01

G3AW94001 / 1001 / 4,000 pcs
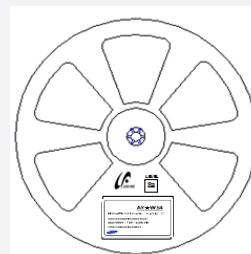
Kitting 'A'   Kitting 'B'
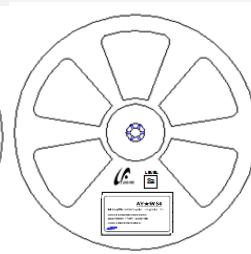
Aluminum Vinyl Packing Bag

Kitting 'A'

G2★WS3
SPMWH1221FD5GB★KS0 G2★WS3 01

G3AW94001 / 1001 / 4,000 pcs

Kitting 'B'

G2★ZS3
SPMWH1221FD5GB★KS0 G2★ZS3 01

G3AW94001 / 1001 / 4,000 pcs

Outer Box

Kitting 'A'

G2★WS4
SPMWH1221FD5GB★KS0 G2★WS3 01

G3AW94001 / 1001 / 20,000 pcs

[BOX Label]

Kitting 'B'

G2★ZS4
SPMWH1221FD5GB★KS0 G2★ZS3 01
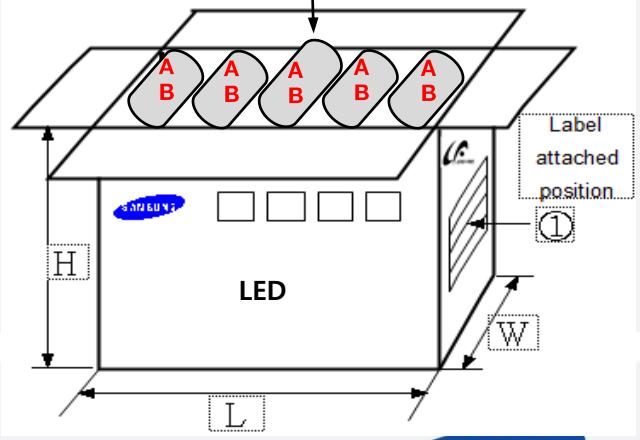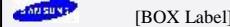
G3AW94001 / 1001 / 20,000 pcs

[BOX Label]

B

A

Material: Paper (SW3B(B))

Type	Size (mm)			Note
	L	W	H	
7 inch L	245 ± 5	220 ± 5	182 ± 5	Up to 10 reels

LED

Label attached position ①

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b) Aluminum Vinyl Packing Bag

CAUTION

LEVEL 2a

This bag contains
MOISTURE SENSITIVE DEVICES

1. Shelf life in sealed bag: 12 months at <40℃ and <90% relative humidity (RH)
2. Peak package body temperature: 240 ℃
3. After this bag is opened, devices that will be subjected to reflow solder or other high temperature processes must be:
   a. Mounted within 672 hours at factory conditions of equal to or less than 30℃ /60% RH, or
   b. Stored at <10% RH
4. Devices require bake, before mounting, if:
   a. Humidity Indicator Card is >60% when read at 23±5℃, or
   b. 2a is not met.
5. If baking is required, devices must be baked for 10～24 hours at 60±5℃
Note: if device containers cannot be subjected to high temperature or shorter bake times are desired, reference IPC/JEDEC J-STD-033 for bake procedure.
Bag seal due date: _____
(if blank, see code label)
Note: Level and body temperature by IPC/JEDEC J-STD-020

G2R1S3

SPMWH1221FD5GBR0S3 G2R1S3   01

G3AYC4001 / 1001 / 4,000 pcs

LEAD-FREE

ATTENTION
OBSERVE PRECAUTIONS FOR HANDLING
ELECTROSTATIC SENSITIVE DEVICES

OTHER

■ 주의 사항

이 알루미늄 지퍼 백은 습기 및 정전기로부터 제품을 보호하기 위하여 제작되었습니다. 개봉 후에는 즉시 솔더 작업을 실시하는 것을 권장합니다.

습기 및 정전기로부터 제품을 보호 하기 위해서 개봉 후 사용하지 않는 자재는 본 팩에 넣어 보관 하시기 바랍니다. 사용하지 않는 자재를 본 팩에 넣을 때는 반드시 동봉된 드라이 팩과 함께 넣고 지퍼부분을 완전하게 밀봉하여 주시기 바랍니다.

■ Important

This Al Zipper bag is designed to protect the enclosed products from moisture and ESD. Once opened, the products should be soldered onto the printed circuit board immediately. When not in use, please do not leave the products unprotected by the Al Zipper Bag. To repack unused products., please ensure the zip-lock is completely sealed with the dry pack left inside.

c) Humidity Indicator Card inside Aluminum Vinyl Bag
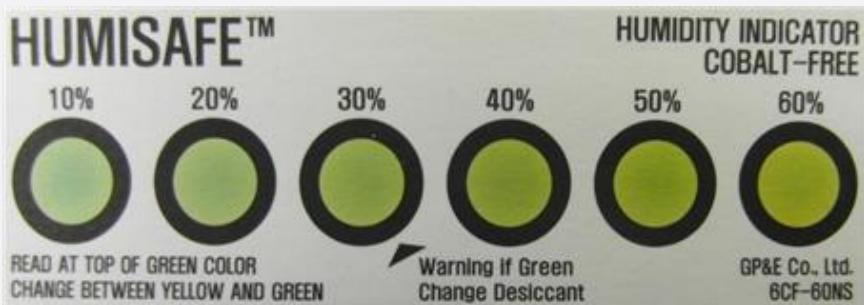
HUMISAFE™   HUMIDITY INDICATOR COBALT-FREE

10%   20%   30%   40%   50%   60%

READ AT TOP OF GREEN COLOR
CHANGE BETWEEN YELLOW AND GREEN

Warning If Green
Change Desiccant

GP&E Co., Ltd.
6CF-60NS

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10. Precautions in Handling & Use

1) For over-current protection, users are recommended to apply resistors connected in series with the LEDs to mitigate sudden change of the forward current caused by shift of forward voltage.

2) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device.

3) When the device is in operation, the forward current should be carefully determined considering the maximum ambient temperature and corresponding junction temperature.

4) LEDs must be stored in a clean environment. If the LEDs are to be stored for three months or more after being shipped from Samsung, they should be packed with a nitrogen-filled container (shelf life of sealed bags is 12 months at temperature 0~40 ℃, 0~90 % RH).

5) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
   a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 ℃ / 60 % RH, or
   b. Stored at <10 % RH

6) Repack unused devices with anti-moisture packing, fold to close any opening and then store in a dry place.

7) Devices require baking before mounting, if humidity card reading is >60 % at 23 ± 5 ℃.

8) Devices must be baked for 1 hour at 60 ± 5 ℃, if baking is required.

9) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.

10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.

11) Risk of sulfurization (or tarnishing)
    The LED from Samsung uses a silver-plated lead frame and its surface color may change to black (or dark colored) when it is exposed to sulfur (S), chlorine (Cl) or other halogen compound. Sulfurization of lead frame may cause intensity degradation, change of chromaticity coordinates and, in extreme cases, open circuit. It requires caution. Due to possible sulfurization of lead frame, LED should not be used and stored together with oxidizing substances made of materials such as rubber, plain paper, lead solder cream, etc.

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Legal and additional information.

About Samsung Electronics Co., Ltd.

Samsung Electronics Co., Ltd. is a global leader in technology,
opening new possibilities for people everywhere. Through relentless
innovation and discovery, we are transforming the worlds of
TVs, smartphones, tablets, PCs, cameras, home appliances, printers,
LTE systems, medical devices, semiconductors and LED solutions.
We employ 286,000 people across 80 countries with annual sales of
US$216.7 billion. To discover more, please visit www.samsungled.com.

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